

### FEATURES

- Very wide bandwidth to 24 GHz
- Time delay range: 70 ps typical
- Single-ended or differential operation
- Adjustable differential output amplitude with 780 mV p-p typical at 10 GHz
- Delay control modulation bandwidth: 1.6 GHz typical
- Single supply: 3.3 V
- 24-terminal ceramic, leadless chip carrier (LCC)

### APPLICATIONS

- Synchronization of clock and data
- Transponder design
- Serial data transmissions up to 32 Gbps
- Broadband test and measurement
- RF ATE applications

### GENERAL DESCRIPTION

The **HMC911** is a broadband time delay with 62 ps to 75 ps continuously adjustable delay range to 24 GHz. The delay control is linearly monotonic with respect to the differential delay control voltage ( $V_{DCP}$  and  $V_{DCN}$ ), and the control input has a modulation bandwidth of 1.6 Hz. The **HMC911** provides a differential output voltage with constant amplitude for single-ended or differential input voltages above the input sensitivity level, and the output voltage swing can be adjusted using the  $V_{AC}$  control pin.

### FUNCTIONAL BLOCK DIAGRAM

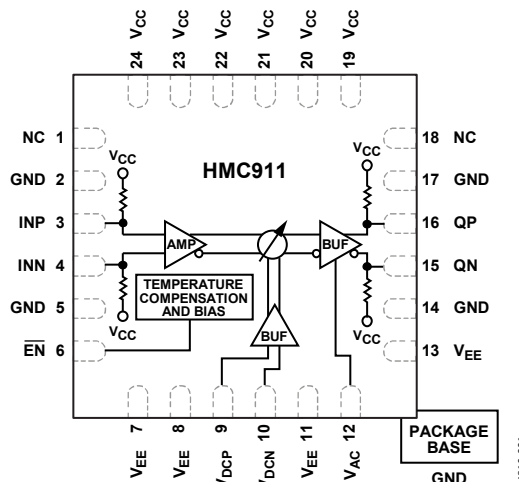


Figure 1.

The **HMC911** features internal temperature compensation and bias circuitry to minimize delay variations with temperature. All RF inputs and outputs of the **HMC911** are internally terminated with 50  $\Omega$  to  $V_{CC}$  and can be ac-coupled or dc-coupled. Output pins connect directly to a 50  $\Omega$  to  $V_{CC}$  terminated system. However, use dc blocking capacitors if the terminated system input is 50  $\Omega$  to a dc voltage other than  $V_{CC}$ .

The **HMC911** is available in a RoHS-compliant, 24-terminal, ceramic, leadless chip carrier.

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## REVISION HISTORY

### 10/2016—Rev. v02.0614 to Rev. B

|                                                                                      |           |
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| Updated Format .....                                                                 | Universal |
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## SPECIFICATIONS

$T_A = 25^\circ\text{C}$ ,  $V_{CC} = 3.3\text{ V}$ ,  $V_{AC} = 2.6\text{ V}$ ,  $V_{EE} = \text{GND} = 0\text{ V}$ , unless otherwise noted.

Table 1.

| Parameter                                                   | Min            | Typ            | Max            | Unit                 | Test Conditions/Comments                                                          |
|-------------------------------------------------------------|----------------|----------------|----------------|----------------------|-----------------------------------------------------------------------------------|
| POWER SUPPLY                                                |                |                |                |                      |                                                                                   |
| Voltage                                                     | 3.13           | 3.3            | 3.47           | V                    | $\pm 5\%$ tolerance                                                               |
| Current                                                     | 460            |                | 530            | mA                   |                                                                                   |
| TIME DELAY RANGE                                            |                |                |                |                      | $V_{DCP} = 3.9\text{ V}$ , $V_{DCN} = 3.3\text{ V}$                               |
| 10 GHz                                                      | 62             | 70             | 71             | ps                   |                                                                                   |
| 18 GHz                                                      | 64             | 70             | 73             | ps                   |                                                                                   |
| 22 GHz                                                      | 66             | 70             | 75             | ps                   |                                                                                   |
| TIME DELAY SENSITIVITY                                      |                |                |                |                      |                                                                                   |
| Voltage                                                     |                | 116            |                | ps/V                 |                                                                                   |
| Temperature                                                 |                | 0.04           |                | ps/ $^\circ\text{C}$ | $V_{DCP} = V_{DCN} = 3.3\text{ V}$ at 18 GHz                                      |
| PHASE SHIFT RANGE                                           |                |                |                |                      | $V_{DCP} = 3.9\text{ V}$ , $V_{DCN} = 3.3\text{ V}$                               |
| 10 GHz                                                      | 210            |                | 250            | Degrees              |                                                                                   |
| 18 GHz                                                      | 400            |                | 475            | Degrees              |                                                                                   |
| 22 GHz                                                      | 515            |                | 595            | Degrees              |                                                                                   |
| MAXIMUM DATA RATE                                           | 32             |                |                | Gbps                 |                                                                                   |
| MAXIMUM CLOCK FREQUENCY                                     | 24             |                |                | GHz                  |                                                                                   |
| DELAY CONTROL                                               |                |                |                |                      |                                                                                   |
| Modulation Bandwidth                                        |                | 1.6            |                | GHz                  |                                                                                   |
| Voltage ( $V_{DCP}$ and $V_{DCN}$ )                         | $V_{CC} - 0.6$ |                | $V_{CC} + 0.6$ | V                    |                                                                                   |
| INPUT VOLTAGE                                               |                |                |                |                      |                                                                                   |
| Low ( $V_{IL}$ )                                            | $V_{CC} - 500$ | $V_{CC} - 200$ | $V_{CC} - 25$  | mV                   |                                                                                   |
| High ( $V_{IH}$ )                                           | $V_{CC} + 25$  | $V_{CC} + 200$ | $V_{CC} + 500$ | mV                   |                                                                                   |
| INPUT AMPLITUDE, PEAK TO PEAK                               |                |                |                |                      |                                                                                   |
| Single Ended                                                | 50             |                | 1000           | mV p-p               |                                                                                   |
| Differential                                                | 100            |                | 2000           | mV p-p               |                                                                                   |
| OUTPUT AMPLITUDE                                            |                |                |                |                      | $V_{AC} = 2.6\text{ V}$                                                           |
| 10 GHz                                                      | 370            | 390            | 640            | mV p-p               | Single-ended                                                                      |
|                                                             | 740            | 780            | 1280           | mV p-p               | Differential                                                                      |
| 18 GHz                                                      | 350            | 375            | 640            | mV p-p               | Single-ended                                                                      |
|                                                             | 700            | 750            | 1280           | mV p-p               | Differential                                                                      |
| 22 GHz                                                      | 340            | 350            | 640            | mV p-p               | Single-ended                                                                      |
|                                                             | 680            | 700            | 1280           | mV p-p               | Differential                                                                      |
| CONTROL VOLTAGE ( $V_{AC}$ )                                | 1.7            | 2.6            | 2.7            | V                    |                                                                                   |
| HARMONIC SUPPRESSION ( $f_{IN} - 2f_{IN}$ ) <sup>1, 2</sup> |                |                |                |                      | $V_{DCP} = V_{DCN} = 3.3\text{ V}$                                                |
| 10 GHz                                                      | 21             |                | 32             | dBc                  |                                                                                   |
| 20 GHz                                                      | 19             |                | 30             | dBc                  |                                                                                   |
| RETURN LOSS                                                 |                |                |                |                      | Frequency < 24 GHz                                                                |
| Input                                                       |                | 9              |                | dB                   |                                                                                   |
| Output                                                      |                | 10             |                | dB                   |                                                                                   |
| RMS JITTER                                                  |                | 0.3            |                | ps, p-p              | 32 Gbps, 10101 ... data                                                           |
| TIME <sup>3</sup>                                           |                |                |                |                      |                                                                                   |
| Rise ( $t_R$ )                                              |                | 15             |                | ps                   |                                                                                   |
| Fall ( $t_F$ )                                              |                | 14             |                | ps                   |                                                                                   |
| PROPAGATION DELAY                                           |                | 480            |                | ps                   | $V_{DCP} = 2.7\text{ V}$ , $V_{DCN} = 3.3\text{ V}$ (relative to zero time delay) |

<sup>1</sup> Harmonic suppression measurements were taken for single-ended inputs and outputs.

<sup>2</sup>  $f_{IN}$  is the fundamental frequency.

<sup>3</sup>  $V_{INPUT} =$  differential 400 mV p-p, and  $f_{DATA} = 22.5\text{ Gbps}$ , and pseudorandom bit sequences (PRBS)  $2^{33} - 1$

## ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter                                                                                                                          | Rating                                        |
|------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------|
| Power Supply Voltage ( $V_{CC}$ )                                                                                                  | –0.5 V to +3.75 V                             |
| Input Voltage ( $V_{IN}$ )                                                                                                         | $V_{CC} - 1.2$ V to $V_{CC} + 0.6$ V          |
| Output Voltage ( $V_{OUT}$ )                                                                                                       | $V_{CC} - 1.2$ V to $V_{CC} + 0.6$ V          |
| Delay Control Voltage ( $V_{DCP}$ , $V_{DCN}$ )                                                                                    | 0 V to $V_{CC} + 0.6$ V                       |
| Power-Down (Enable) Pin ( $\overline{EN}$ )                                                                                        | 0 V to $V_{CC} + 0.6$ V                       |
| Amplitude Control ( $V_{AC}$ )                                                                                                     | 0 V to $V_{CC} + 0.6$ V                       |
| Continuous Power Dissipation, $P_{DISS}$ ( $T_A = 85^\circ\text{C}$ , Derate 54.96 mW/ $^\circ\text{C}$ above $85^\circ\text{C}$ ) | 2.2 W                                         |
| Thermal Resistance (Junction to Ground Paddle)                                                                                     | 18.2 $^\circ\text{C}/\text{W}$                |
| Channel Temperature ( $T_C$ )                                                                                                      | 125 $^\circ\text{C}$                          |
| Maximum Peak Reflow Temperature (MSL3) <sup>1</sup>                                                                                | 260 $^\circ\text{C}$                          |
| Storage Temperature Range                                                                                                          | –65 $^\circ\text{C}$ to +125 $^\circ\text{C}$ |
| Operating Temperature Range                                                                                                        | –40 $^\circ\text{C}$ to +85 $^\circ\text{C}$  |
| Electrostatic Discharge (ESD)                                                                                                      |                                               |
| Human Body Model (HBM)                                                                                                             | Class 1B                                      |

<sup>1</sup> See the Ordering Guide section.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

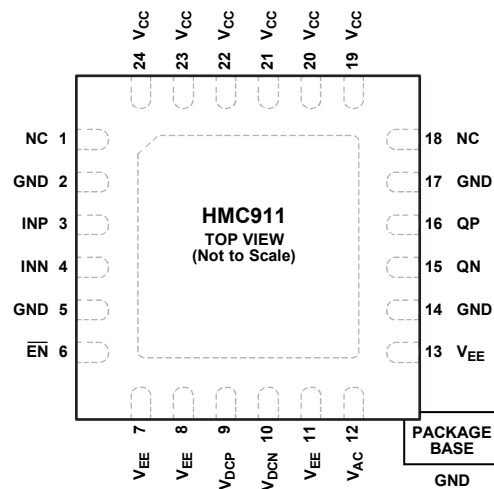
### ESD CAUTION



#### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES  
 1. NC = NO CONNECT.  
 2. EXPOSED PAD. CONNECT THE EXPOSED PAD TO RF/DC GROUND

1481E-002

Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

| Pin No.      | Mnemonic | Description                                                                                                                                                                                                                                        |
|--------------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1, 18        | NC       | No Connect. These pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/dc ground externally.                                                                                             |
| 2, 5, 14, 17 | GND      | Ground Pin. Connect these signal grounds to 0 V. See Figure 3 for the interface schematic.                                                                                                                                                         |
| 3            | INP      | Positive Differential RF Input Pin. See Figure 4 for the interface schematic.                                                                                                                                                                      |
| 4            | INN      | Negative Differential RF Input Pin. See Figure 4 for the interface schematic.                                                                                                                                                                      |
| 6            | EN       | Enable Pin for the Time Delay. For normal operation, leave this pin open or apply 3.3 V. To disable the <a href="#">HMC911</a> , apply 0 V. When disabled, the total current consumption drops to 15 mA. See Figure 5 for the interface schematic. |
| 7, 8, 11, 13 | VEE      | Supply Grounds. Connect these pins to 0 V. See Figure 6 for the interface schematic.                                                                                                                                                               |
| 9            | VDCP     | Positive Differential Time Delay Control Pin. See Figure 7 for the interface schematic.                                                                                                                                                            |
| 10           | VDCN     | Negative Differential Time Delay Control Pin. See Figure 7 for the interface schematic.                                                                                                                                                            |
| 12           | VAC      | Output Amplitude Control Pin. See Figure 8 for the interface schematic.                                                                                                                                                                            |
| 15           | QN       | Negative Differential RF Output Pin. See Figure 9 for the interface schematic.                                                                                                                                                                     |
| 16           | QP       | Positive Differential RF Output Pin. See Figure 9 for the interface schematic.                                                                                                                                                                     |
| 19 to 24     | VCC      | Positive Supply Pins. See Figure 10 for the interface schematic.                                                                                                                                                                                   |
|              | EPAD     | Exposed Pad. Connect the exposed pad to RF/dc ground.                                                                                                                                                                                              |

## INTERFACE SCHEMATICS



Figure 3. GND Interface Schematic

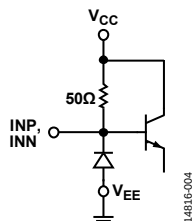


Figure 4. INP and INN Interface Schematic

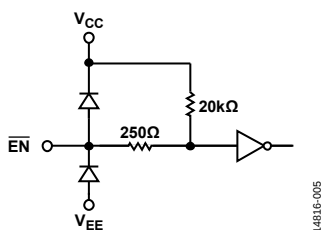
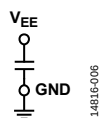
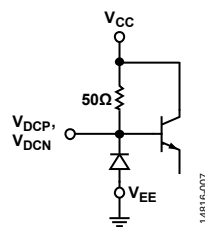
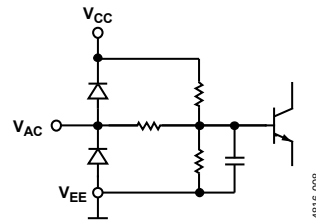
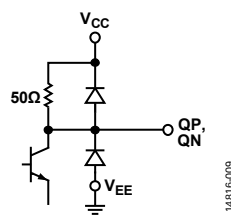
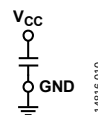
Figure 5.  $\overline{EN}$  Interface SchematicFigure 6.  $V_{EE}$  Interface SchematicFigure 7.  $V_{DCP}$  and  $V_{DCN}$  Interface SchematicFigure 8.  $V_{AC}$  Interface Schematic

Figure 9. QN and QP Interface Schematic

Figure 10.  $V_{CC}$  Interface Schematic

## TYPICAL PERFORMANCE CHARACTERISTICS

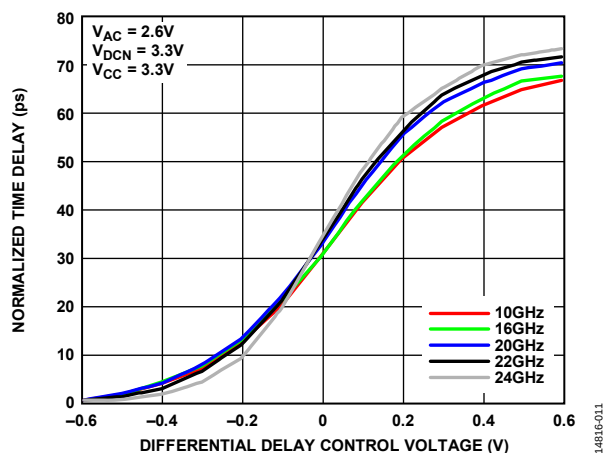


Figure 11. Normalized Time Delay vs. Differential Delay Control Voltage, Differential Delay Control Voltage Represents  $V_{DCP} - V_{DCN}$  Voltage on the X-Axis

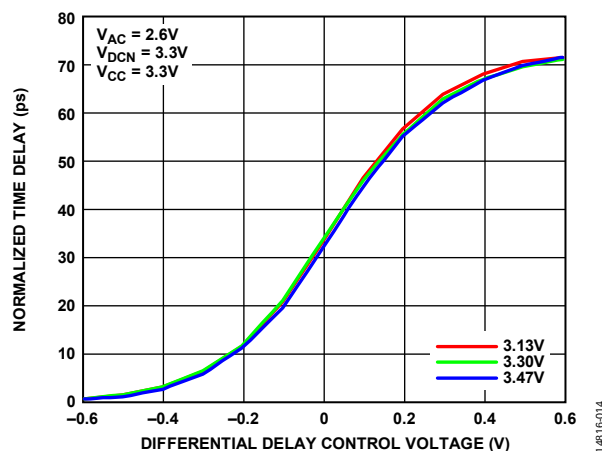


Figure 14. Normalized Time Delay vs. Differential Delay Control Voltage at 22 GHz for Various Voltages, Differential Delay Control Voltage Represents  $V_{DCP} - V_{DCN}$  Voltage on the X-Axis

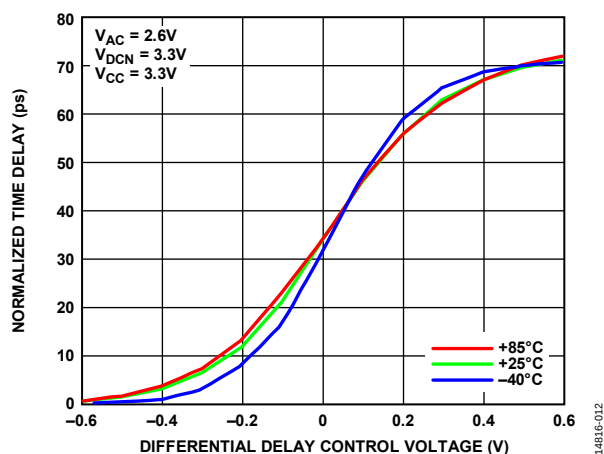


Figure 12. Normalized Time Delay vs. Differential Delay Control Voltage at 22 GHz for Various Temperatures, Differential Delay Control Voltage Represents  $V_{DCP} - V_{DCN}$  Voltage on the X-Axis

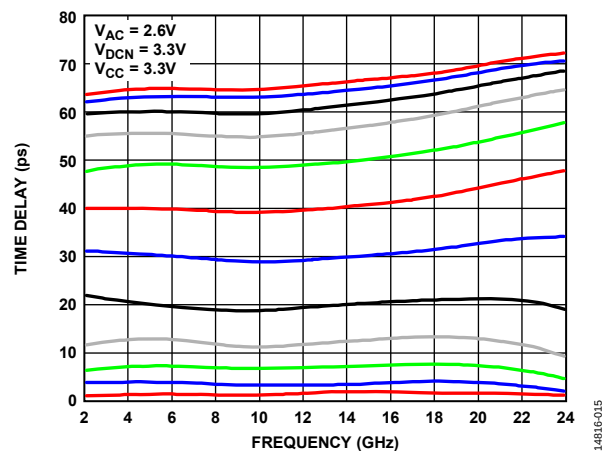


Figure 15. Time Delay vs. Frequency at  $V_{DCP} = 2.7$  V to 3.9 V with 0.1 V Step

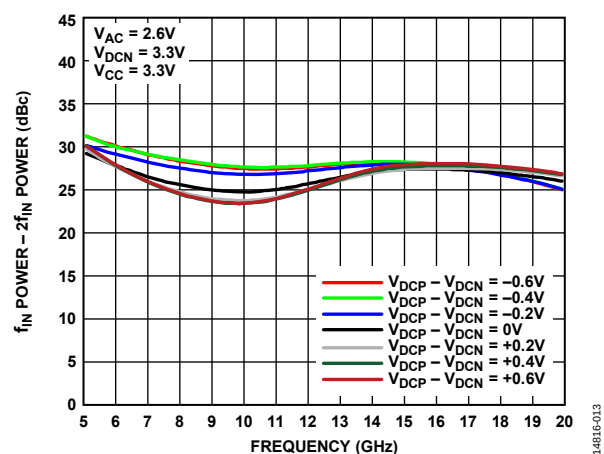


Figure 13.  $f_{IN}$  Power -  $2f_{IN}$  Power vs. Frequency

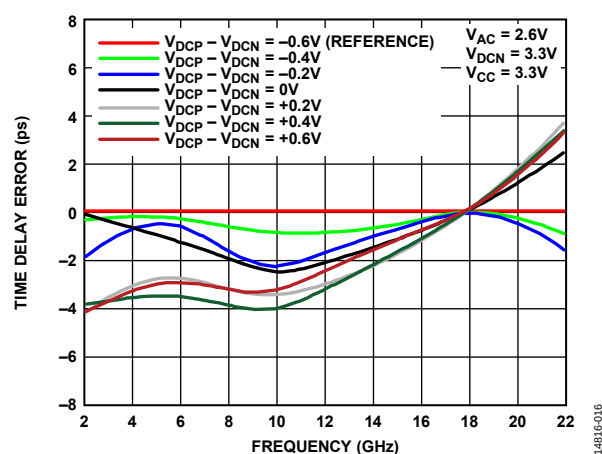


Figure 16. Time Delay Error vs. Frequency at Mean Frequency ( $f_{MEAN}$ ) = 18 GHz

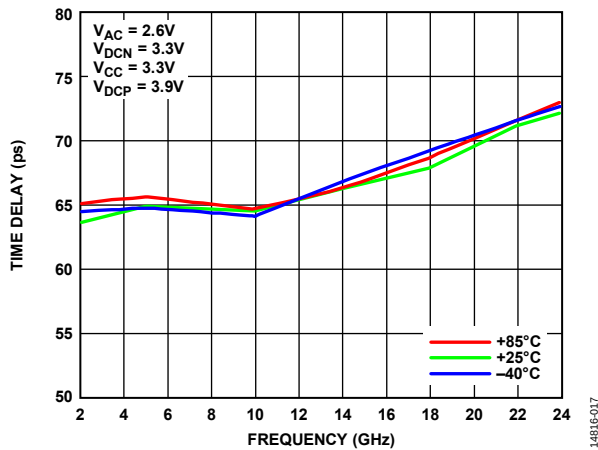


Figure 17. Programmable Maximum Time Delay vs. Frequency for Various Temperatures

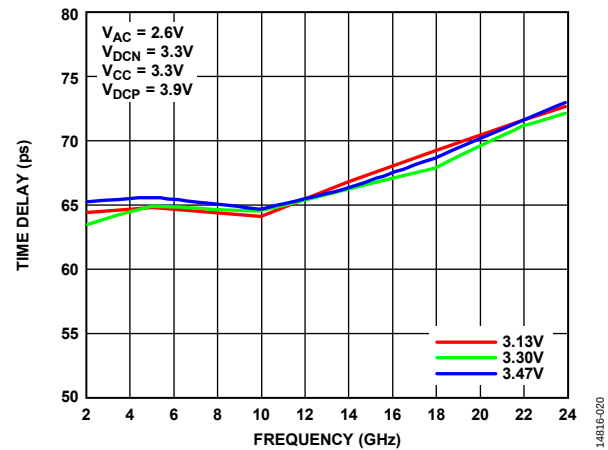


Figure 20. Programmable Maximum Time Delay vs. Frequency for Various Voltages

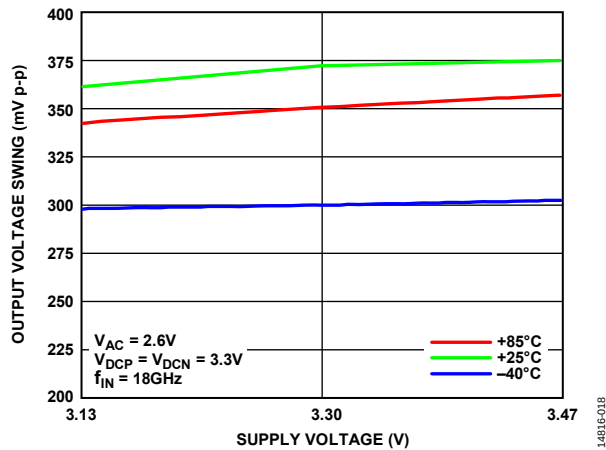


Figure 18. Single-Ended Output Voltage Swing vs. Supply Voltage for Various Temperatures

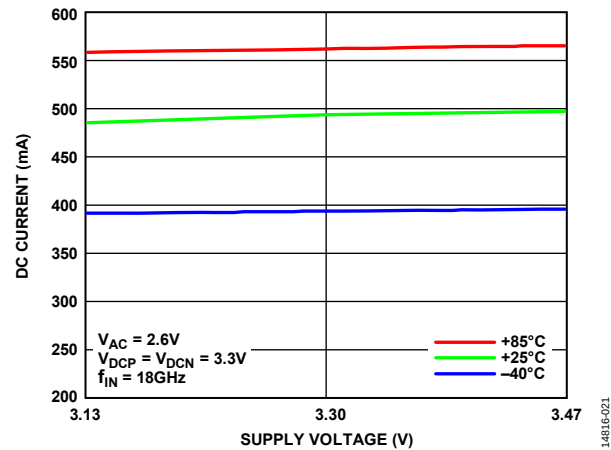


Figure 21. DC Current vs. Supply Voltage for Various Temperatures

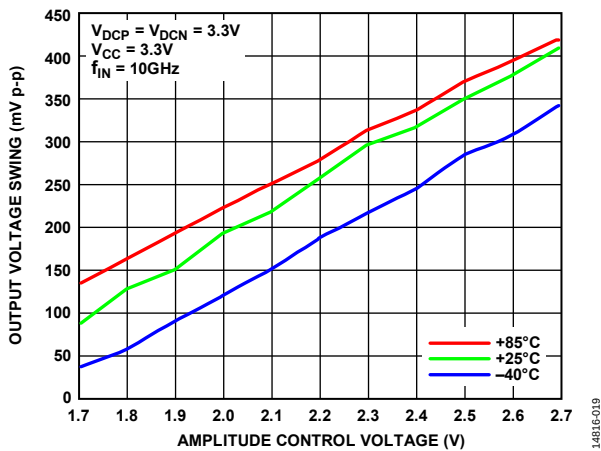


Figure 19. Single-Ended Output Voltage Swing vs. Amplitude Control Voltage ( $V_{AC}$ ) for Various Temperatures

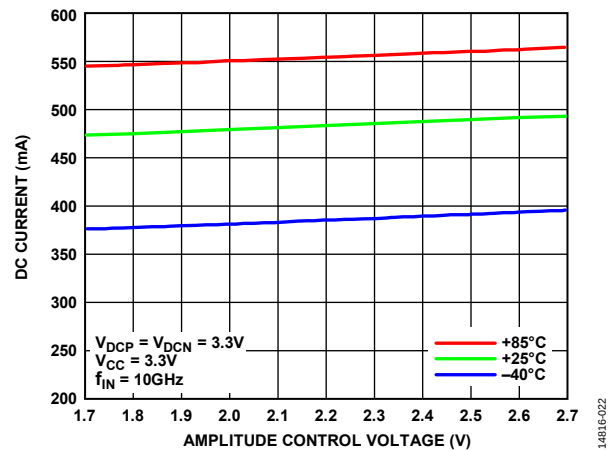


Figure 22. DC Current vs. Amplitude Control Voltage ( $V_{AC}$ ) for Various Temperatures

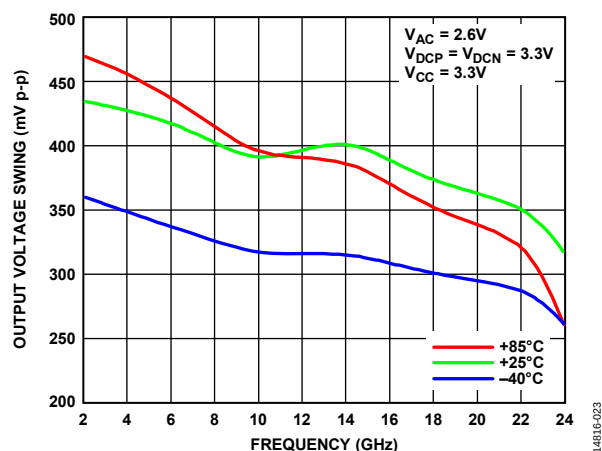


Figure 23. Single-Ended Output Voltage Swing vs. Frequency for Various Temperatures

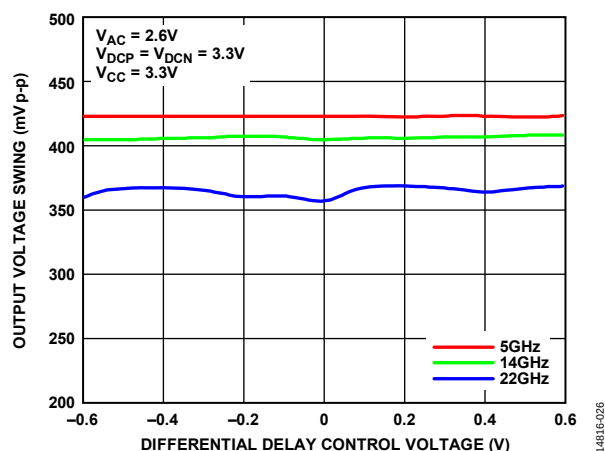


Figure 26. Single-Ended Output Voltage Swing vs. Differential Delay Control Voltage, Differential Control Voltage Represents  $V_{DCP} - V_{DCN}$  Voltage on the X-Axis

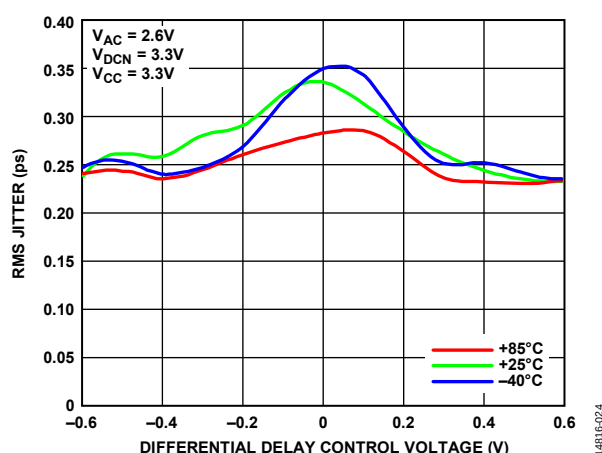


Figure 24. RMS Jitter vs. Differential Delay Control Voltage at 18 GHz for Various Temperatures, Differential Control Voltage Represents  $V_{DCP} - V_{DCN}$  Voltage on the X-Axis

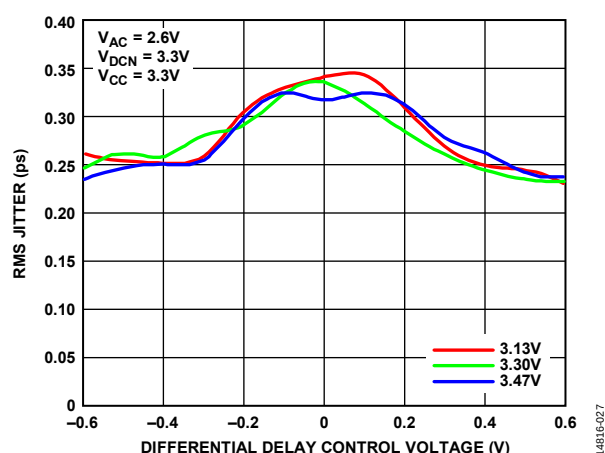


Figure 27. RMS Jitter vs. Differential Delay Control Voltage at 18 GHz for Various Voltages, Differential Control Voltage Represents  $V_{DCP} - V_{DCN}$  Voltage on the X-Axis

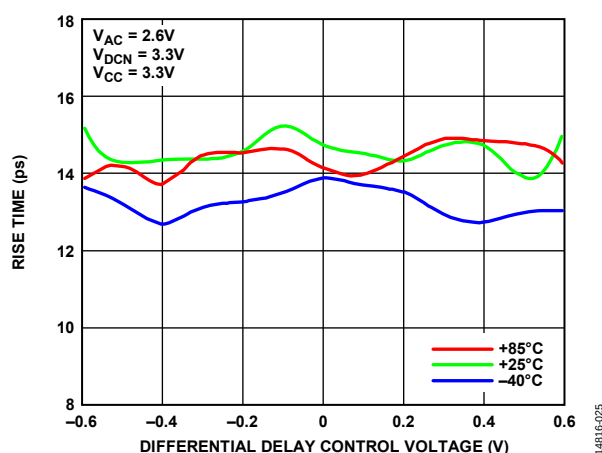


Figure 25. Rise Time vs. Differential Delay Control Voltage, Differential Control Voltage Represents  $V_{DCP} - V_{DCN}$  Voltage on the X-Axis, Input Data Rate = 22.5 Gbps, PRBS  $2^{33} - 1$

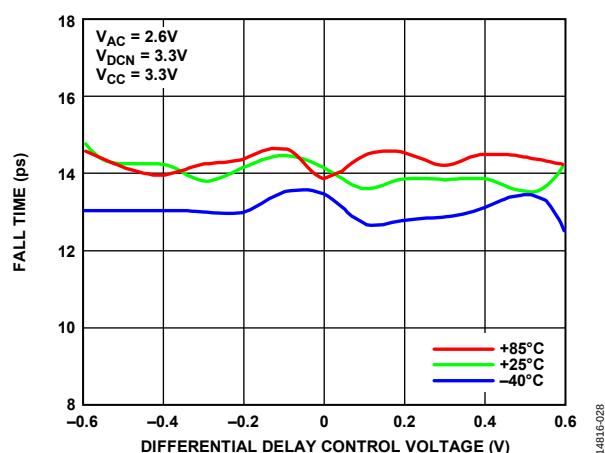


Figure 28. Fall Time vs. Differential Delay Control Voltage, Differential Control Voltage Represents  $V_{DCP} - V_{DCN}$  Voltage on the X-Axis, Input Data Rate = 22.5 Gbps, PRBS  $2^{33} - 1$

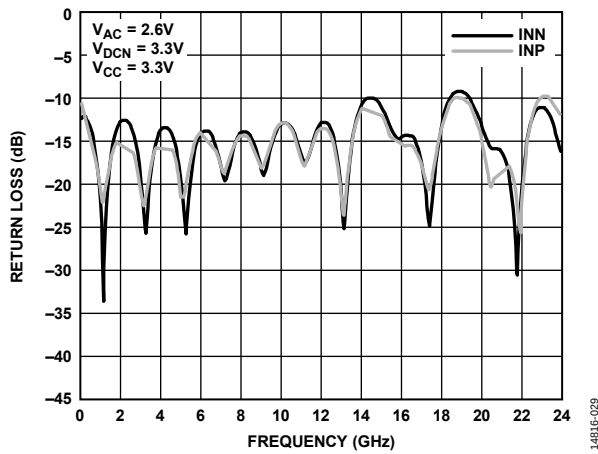


Figure 29. Input Return Loss vs. Frequency,

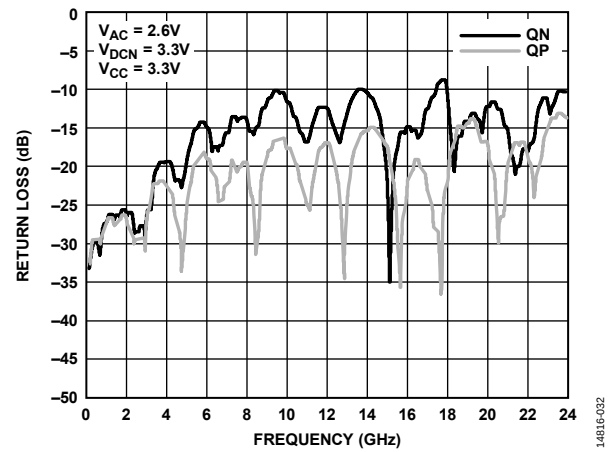


Figure 32. Output Return Loss vs. Frequency,

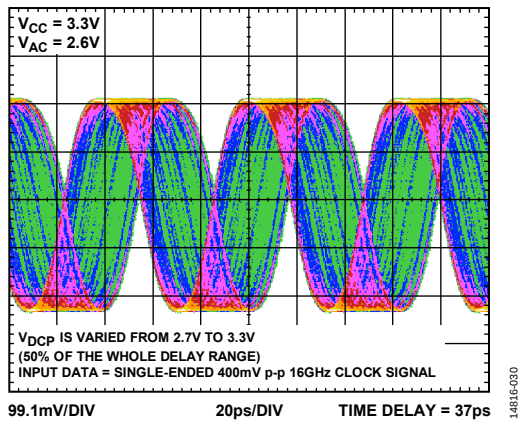


Figure 30. Output Eye Diagram Continuous Snapshot for 16 GHz Input

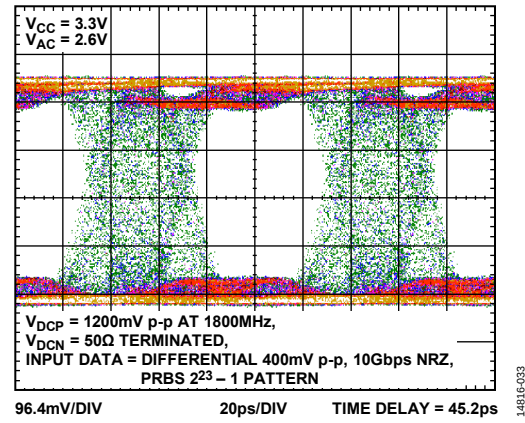
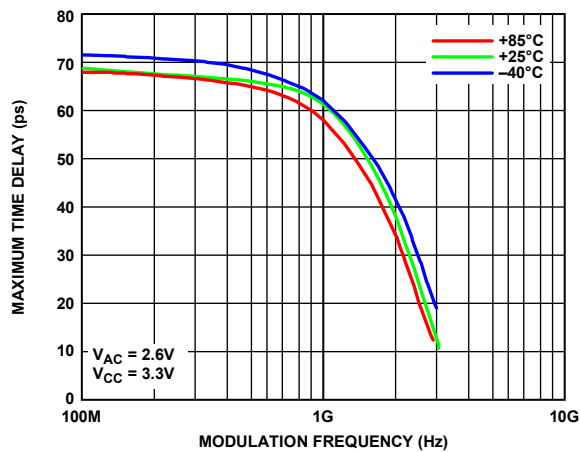


Figure 33. Output Eye Diagram Continuous Snapshot for 10 Gbps Input

Figure 31. Maximum Time Delay vs. Modulation Frequency,  
Input Data Rate = 22.5 Gbps, PRBS 2<sup>33</sup> - 1, 6 dBm Input Power Applied to  
V<sub>DCP</sub> and V<sub>DCN</sub> Terminated to 50 Ω

## APPLICATIONS INFORMATION

### EVALUATION PRINTED CIRCUIT BOARD (PCB)

Generate the evaluation PCB used in this application with proper RF circuit design techniques. Signal lines at the RF port must have 50  $\Omega$  impedance, and the package ground leads and exposed paddle must be connected directly to the ground plane similar to what is shown in Figure 34. Use a sufficient number

of via holes to connect the top and bottom ground planes. Mount the evaluation board to an appropriate heat sink. The evaluation PCB shown is available from Analog Devices, Inc., upon request.

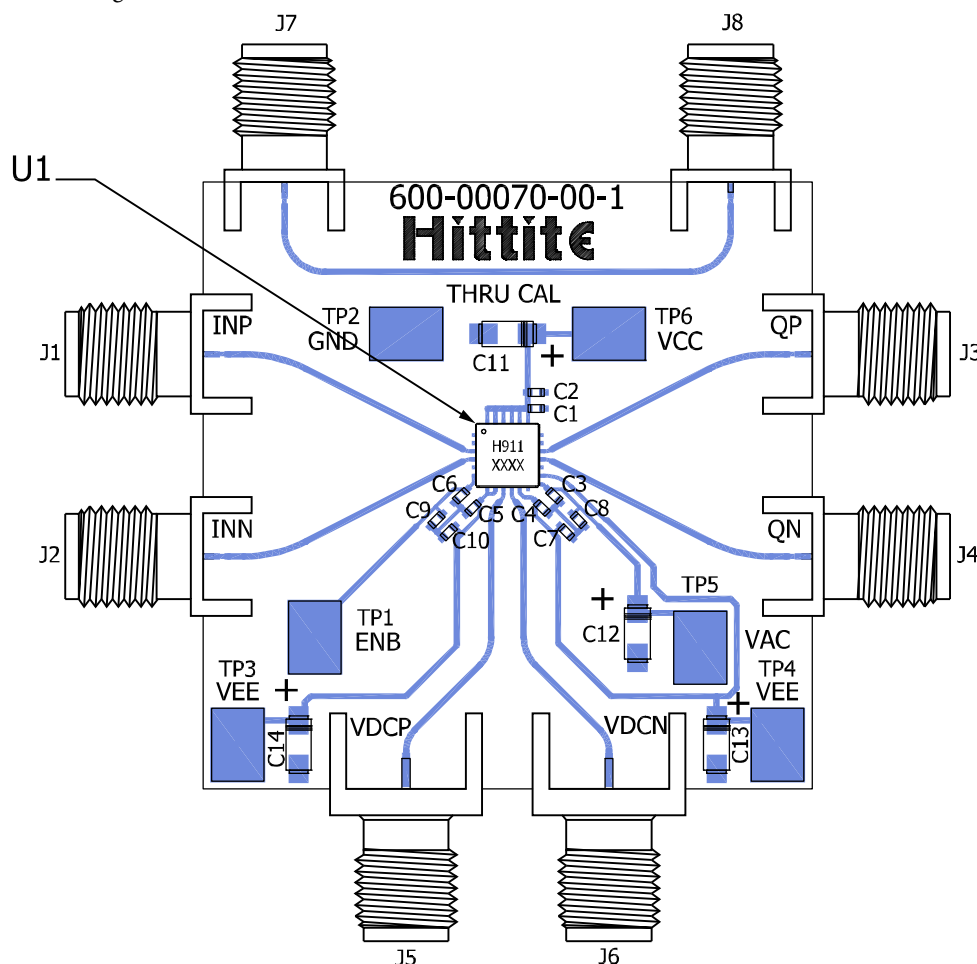


Figure 34. 600-00070-00-1 (EVAL01-HMC911LC4B) Evaluation Board

14816-035

### Bill of Materials

Table 4.

| Component     | Description                                                                                                         |
|---------------|---------------------------------------------------------------------------------------------------------------------|
| J1 to J4      | K connectors                                                                                                        |
| J5, J6        | SMA connectors                                                                                                      |
| J7, J8        | SMA connectors for through calibration                                                                              |
| TP1 to TP6    | DC test points                                                                                                      |
| C1, C3 to C6  | 1 nF capacitors, 0402 package                                                                                       |
| C2, C7 to C10 | 0.1 $\mu$ F capacitors, 0402 package                                                                                |
| C9            | 100 nF capacitor, 0402 package                                                                                      |
| C11 to C14    | 4.7 $\mu$ F tantalum capacitors                                                                                     |
| U1            | HMC911 analog phase shifter                                                                                         |
| PCB           | 600-00070-00-1 (EVAL01-HMC911LC4B <sup>1</sup> ) evaluation PCB, circuit board material: Rogers 4350 or Arlon 25 FR |

<sup>1</sup> Reference this number when ordering the completed evaluation PCB.

## TYPICAL APPLICATION CIRCUIT

Figure 35 shows the typical application circuit. Note that TP2 goes to ground and is not shown in Figure 35.

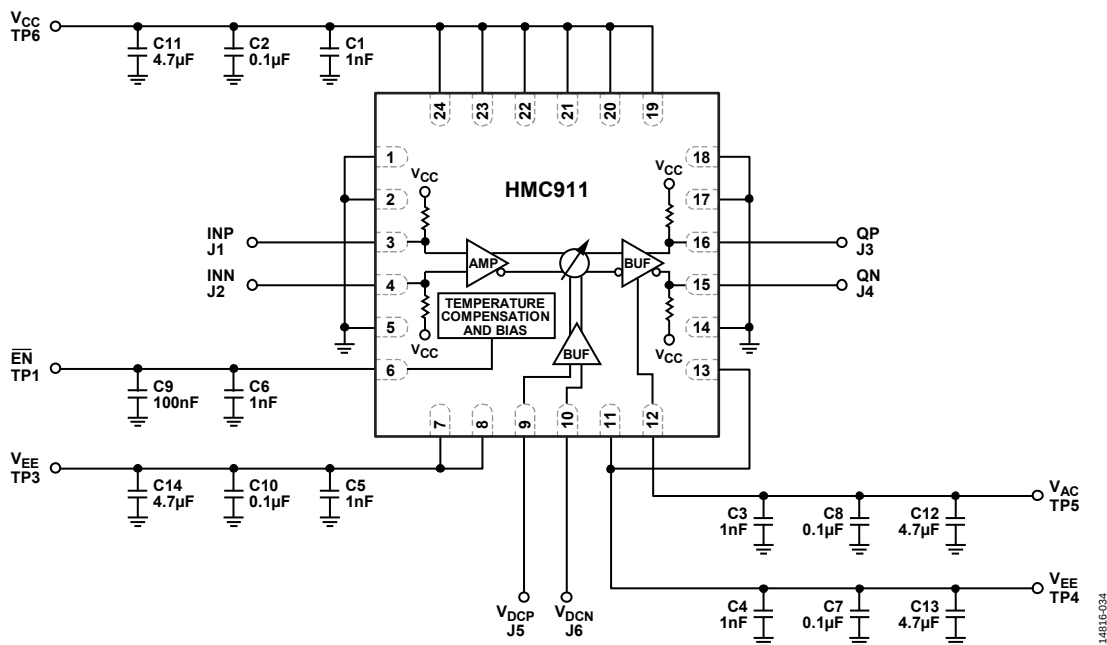


Figure 35. Typical Application Circuit

148316-034

## OUTLINE DIMENSIONS

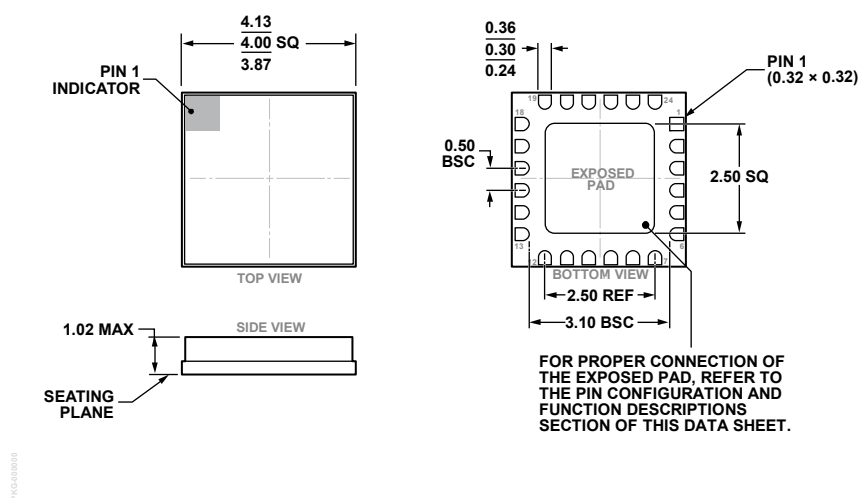


Figure 36. 24-Terminal Ceramic Leadless Chip [LCC]  
(E-24-1)  
Dimensions shown in millimeters

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Body Material | Lead Finish      | MSL Rating <sup>2</sup> | Package Description | Package Option |
|--------------------|-------------------|-----------------------|------------------|-------------------------|---------------------|----------------|
| HMC911LC4B         | −40°C to +85°C    | Alumina, White        | Gold over Nickel | MSL3                    | 24-Terminal LCC     | E-24-1         |
| HMC911LC4BTR       | −40°C to +85°C    | Alumina, White        | Gold over Nickel | MSL3                    | 24-Terminal LCC     | E-24-1         |
| HMC911LC4BTR-R5    | −40°C to +85°C    | Alumina, White        | Gold over Nickel | MSL3                    | 24-Terminal LCC     | E-24-1         |
| EVAL01-HMC911LC4B  |                   |                       |                  |                         | Evaluation Board    |                |

<sup>1</sup> The HMC911LC4B, HMC911LC4BTR, and HMC911LC4BTR-R5 are RoHS Compliant Parts.

<sup>2</sup> See the Absolute Maximum Ratings section for additional information.

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